TOSHIBA Field Effect Transistor Silicon N, P Channel MOS Type
(P Channel U−MOS IV/N Channel U-MOS III)

TPC8405

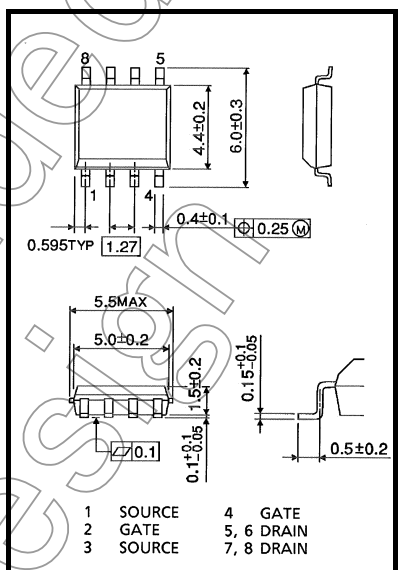
Lithium Ion Secondary Battery Applications

Portable Equipment Applications

Notebook PC Applications

- Low drain-source ON resistance : P Channel $R_{DS\ (ON)}$ = 25 mΩ (typ.)
  N Channel $R_{DS\ (ON)}$ = 20 mΩ (typ.)
- High forward transfer admittance : P Channel $|Y_{fs}|$ = 12S (typ.)
  N Channel $|Y_{fs}|$ = 14S (typ.)
- Low leakage current : P Channel I_{DSS} = −10 μA (V_{DS} = −30 V)
  N Channel I_{DSS} = 10 μA (V_{DS} = 30 V)
- Enhancement-mode
  : P Channel V_{th} = −0.8 to −2.0 V (V_{DS} = −10 V, I_D = −1 mA)
  N Channel V_{th} = 1.3 to 2.5 V (V_{DS} = 10 V, I_D = 1 mA)

Unit: mm



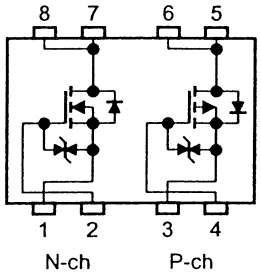
JEDEC	—
JEITA	—
TOSHIBA	2-6J1E

Weight: 0.080 g (typ.)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating		Unit
			P Channel	N Channel	
Drain-source voltage		V_{DSS}	−30	30	V
Drain-gate voltage (R_{GS} = 20 kΩ)		V_{DGR}	−30	30	V
Gate-source voltage		V_{GSS}	±20	±20	V
Drain current	DC (Note 1)	I_D	−4.5	6	A
	Pulse (Note 1)	I_{DP}	−18	24	
Drain power dissipation (t = 10s) (Note 2a)	Single-device operation (Note 3a)	$P_{D\ (1)}$	1.5	1.5	W
	Single-device value at dual operation (Note 3b)	$P_{D\ (2)}$	1.1	1.1	
Drain power dissipation (t = 10s) (Note 2b)	Single-device operation (Note 3a)	$P_{D\ (1)}$	0.75	0.75	
	Single-device value at dual operation (Note 3b)	$P_{D\ (2)}$	0.45	0.45	
Single pulse avalanche energy		E_{AS}	13.2 (Note 4a)	23.4 (Note 4b)	mJ
Avalanche current		I_{AR}	−4.5	6	A
Repetitive avalanche energy Single-device value at operation (Note 2a, 3b, 5)		E_{AR}	0.1		mJ
Channel temperature		T_{ch}	150		°C
Storage temperature range		T_{stg}	−55 to 150		°C

Circuit Configuration



Note: For Notes 1 to 5, refer to the next page.

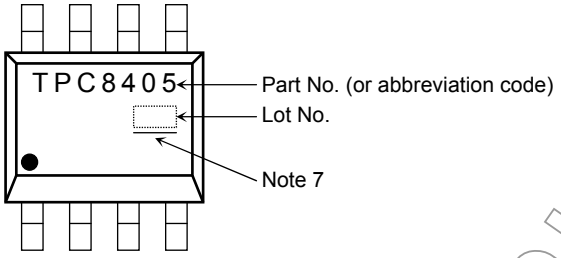
Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook (“Handling Precautions”/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

This transistor is an electrostatic-sensitive device. Handle with care.

Thermal Characteristics

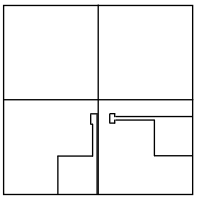
Characteristics		Symbol	Max	Unit
Thermal resistance, channel to ambient (t = 10s) (Note 2a)	Single-device operation (Note 3a)	$R_{th\ (ch\text{-}a)\ (1)}$	83.3	°C/W
	Single-device value at dual operation (Note 3b)	$R_{th\ (ch\text{-}a)\ (2)}$	114	
Thermal resistance, channel to ambient (t = 10s) (Note 2b)	Single-device operation (Note 3a)	$R_{th\ (ch\text{-}a)\ (1)}$	167	
	Single-device value at dual operation (Note 3b)	$R_{th\ (ch\text{-}a)\ (2)}$	278	

Marking (Note 6)

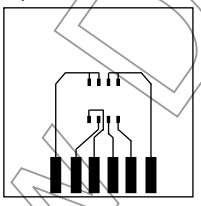


Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: a) Device mounted on a glass-epoxy board (a) b) Device mounted on a glass-epoxy board (b)



(a)



(b)

Note 3: a) The power dissipation and thermal resistance values shown are for a single device.
(During single-device operation, power is applied to one device only.)
b) The power dissipation and thermal resistance values shown are for a single device.
(During dual operation, power is evenly applied to both devices.)

Note 4: a) V_{DD} = −24 V, T_{ch} = 25°C (initial), L = 0.5 mH, R_G = 25 Ω, I_{AR} = −4.5 A
b) V_{DD} = 24 V, T_{ch} = 25°C (initial), L = 0.5 mH, R_G = 25 Ω, I_{AR} = 6.0 A

Note 5: Repetitive rating: pulse width limited by maximum channel temperature

Note 6: • on the lower left of the marking indicates Pin 1.

* Weekly code: (Three digits)

Week of manufacture
(01 for first week of year, continuing up to 52 or 53)

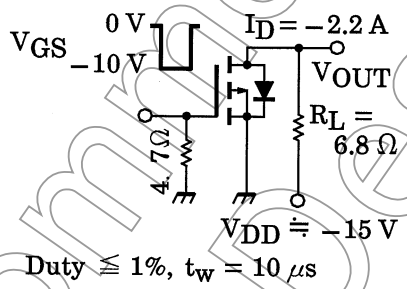
Year of manufacture
(The last digit of the calendar year)

Note 7: A line under a Lot No. identifies the indication of product Labels.
Not underlined: [[Pb]]/INCLUDES > MCV
Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

P-ch

Electrical Characteristics (Ta = 25°C)

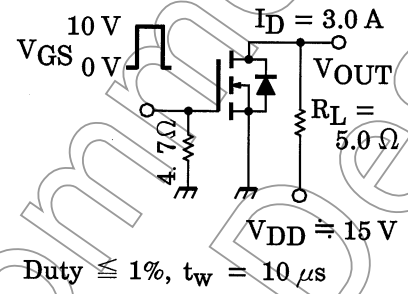
Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current		I_{GSS}	V_{GS} = ±16 V, V_{DS} = 0 V	—	—	±10	μA
Drain cut-OFF current		I_{DSS}	V_{DS} = −30 V, V_{GS} = 0 V	—	—	−10	μA
Drain-source breakdown voltage		$V_{(BR)\ DSS}$	I_D = −10 mA, V_{GS} = 0 V	−30	—	—	V
		$V_{(BR)\ DSX}$	I_D = −10 mA, V_{GS} = 20 V	−15	—	—	
Gate threshold voltage		V_{th}	V_{DS} = −10 V, I_D = −1 mA	−0.8	—	−2.0	V
Drain-source ON resistance		$R_{DS\ (ON)}$	V_{GS} = −4.5 V, I_D = −2.2 A	—	32	42	mΩ
		$R_{DS\ (ON)}$	V_{GS} = −10 V, I_D = −2.2 A	—	25	33	
Forward transfer admittance		$\|Y_{fs}\|$	V_{DS} = −10 V, I_D = −2.2 A	6	12	—	S
Input capacitance		C_{iss}	V_{DS} = −10 V, V_{GS} = 0 V, f = 1 MHz	—	1540	—	pF
Reverse transfer capacitance		C_{rss}		—	220	—	
Output capacitance		C_{oss}		—	250	—	
Switching time	Rise time	t_r		—	5.0	—	ns
	Turn-ON time	t_{on}		—	13	—	
	Fall time	t_f		—	35	—	
	Turn-OFF time	t_{off}		—	125	—	
Total gate charge (Gate-source plus gate-drain)		Q_g	V_{DD} ≈ −24 V, V_{GS} = −10 V, I_D = −4.5 A	—	40	—	nC
Gate-source charge 1		Q_{gs1}		—	4.4	—	
Gate-drain (“miller”) charge		Q_{gd}		—	8.2	—	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Drain reverse current	Pulse (Note 1)	I_{DRP}	—	—	—	−18	A
Forward voltage (diode)		V_{DSF}	I_{DR} = −4.5 A, V_{GS} = 0 V	—	—	1.2	V

N-ch

Electrical Characteristics (Ta = 25°C)

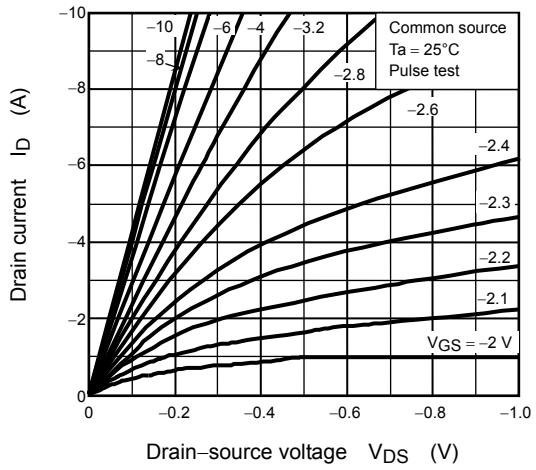
Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current		I_{GSS}	V_{GS} = ±16 V, V_{DS} = 0 V	—	—	±10	μA
Drain cut-OFF current		I_{DSS}	V_{DS} = 30 V, V_{GS} = 0 V	—	—	10	μA
Drain-source breakdown voltage		$V_{(BR)\ DSS}$	I_D = 10 mA, V_{GS} = 0 V	30	—	—	V
		$V_{(BR)\ DSX}$	I_D = 10 mA, V_{GS} = −20 V	15	—	—	
Gate threshold voltage		V_{th}	V_{DS} = 10 V, I_D = 1 mA	1.3	—	2.5	V
Drain-source ON resistance		$R_{DS\ (ON)}$	V_{GS} = 4.5 V, I_D = 3 A	—	25	33	mΩ
		$R_{DS\ (ON)}$	V_{GS} = 10 V, I_D = 3 A	—	20	26	
Forward transfer admittance		$\|Y_{fs}\|$	V_{DS} = 10 V, I_D = 3 A	7	14	—	S
Input capacitance		C_{iss}	V_{DS} = 10 V, V_{GS} = 0 V, f = 1 MHz	—	1240	—	pF
Reverse transfer capacitance		C_{rss}		—	180	—	
Output capacitance		C_{oss}		—	230	—	
Switching time	Rise time	t_r		—	4.5	—	ns
	Turn-ON time	t_{on}		—	12.5	—	
	Fall time	t_f		—	6.6	—	
	Turn-OFF time	t_{off}		—	33	—	
Total gate charge (Gate-source plus gate-drain)		Q_g	V_{DD} ≈ 24 V, V_{GS} = 10 V, I_D = 6 A	—	27	—	nC
Gate-source charge 1		Q_{gs1}		—	3.9	—	
Gate-drain (“miller”) charge		Q_{gd}		—	7.0	—	

Source-Drain Ratings and Characteristics (Ta = 25°C)

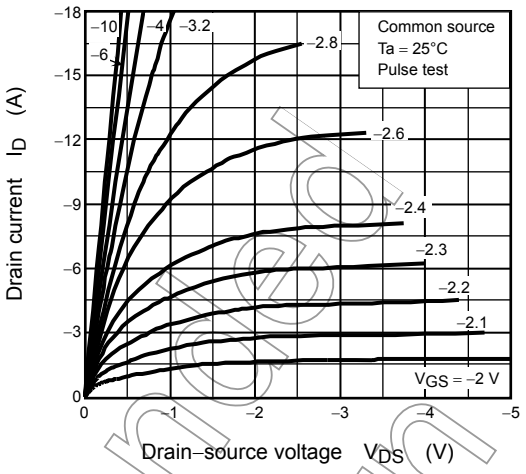
Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Drain reverse current	Pulse (Note 1)	I_{DRP}	—	—	—	24	A
Forward voltage (diode)		V_{DSF}	I_{DR} = 6 A, V_{GS} = 0 V	—	—	−1.2	V

P-ch

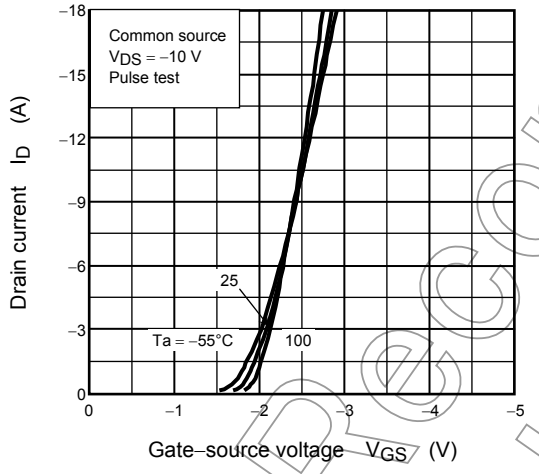
$I_D - V_{DS}$



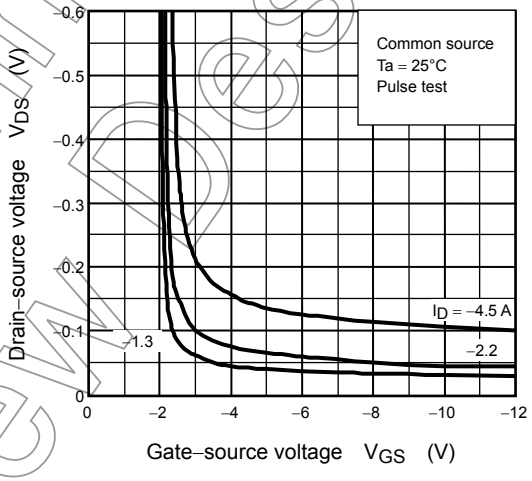
$I_D - V_{DS}$



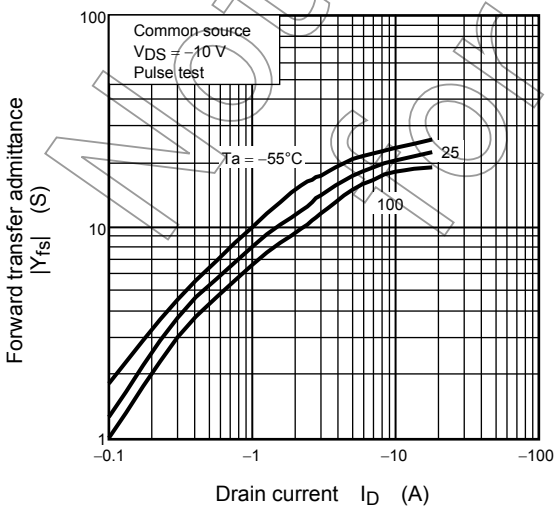
$I_D - V_{GS}$



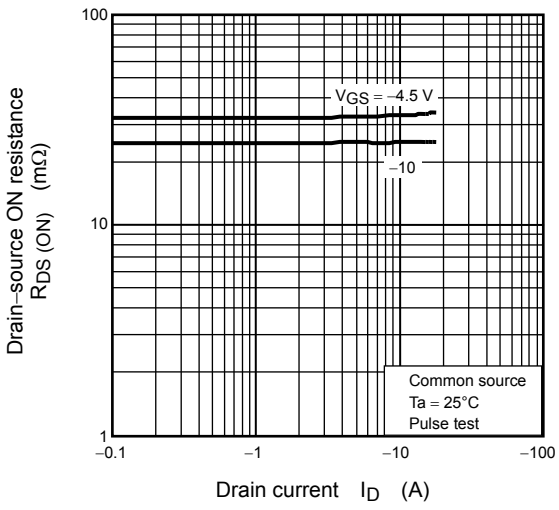
$V_{DS} - V_{GS}$



$|Y_{fs}| - I_D$

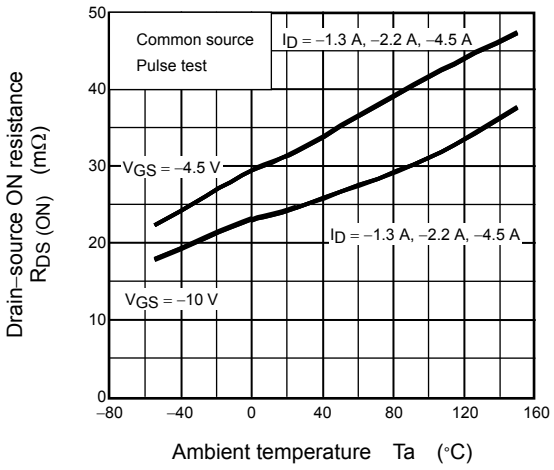


$R_{DS\ (ON)} - I_D$

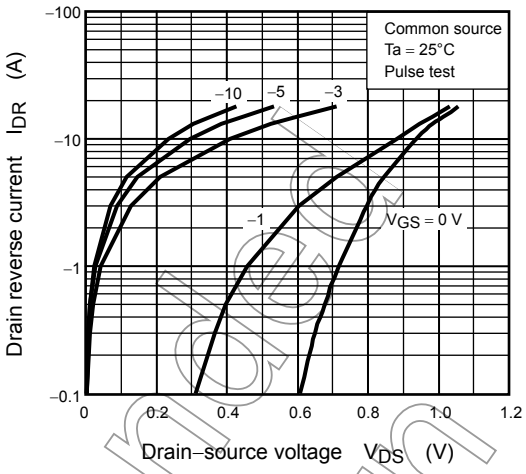


P-ch

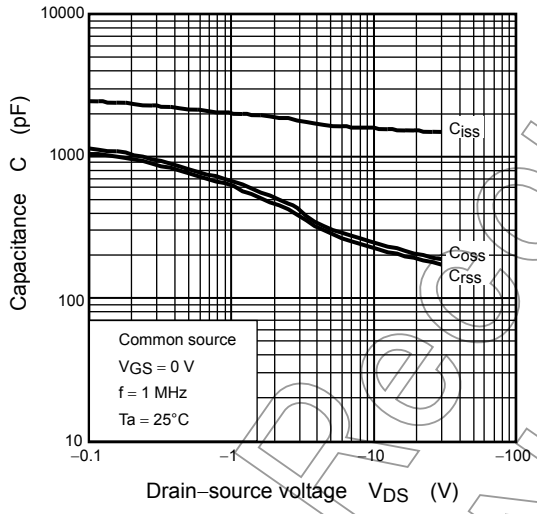
$R_{DS\ (ON)}$ – Ta



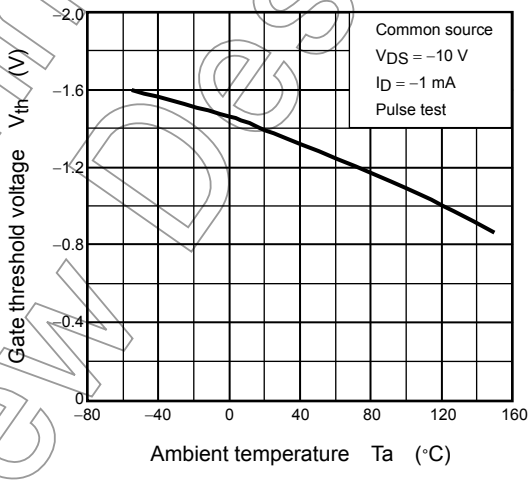
I_{DR} – V_{DS}



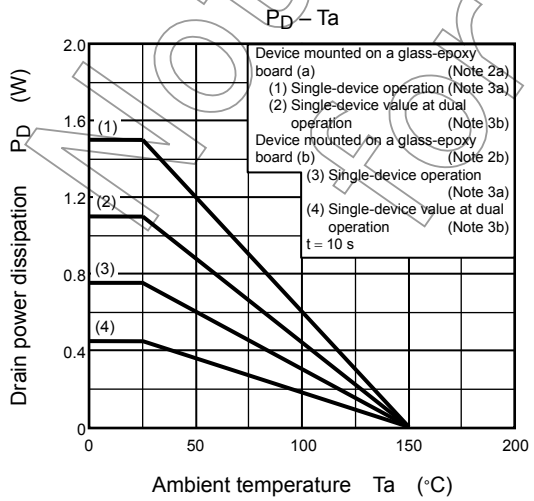
C – V_{DS}



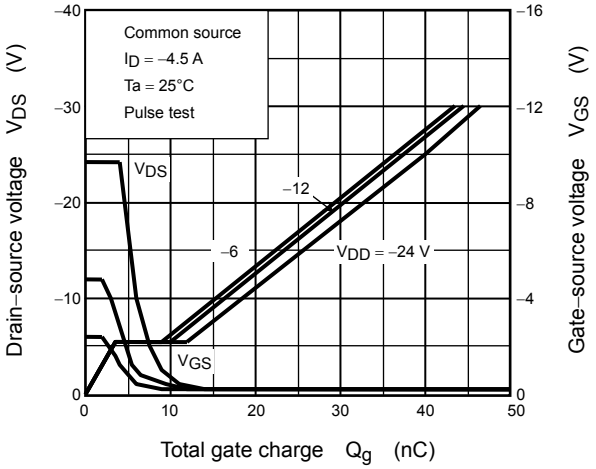
V_{th} – Ta



P_D – Ta

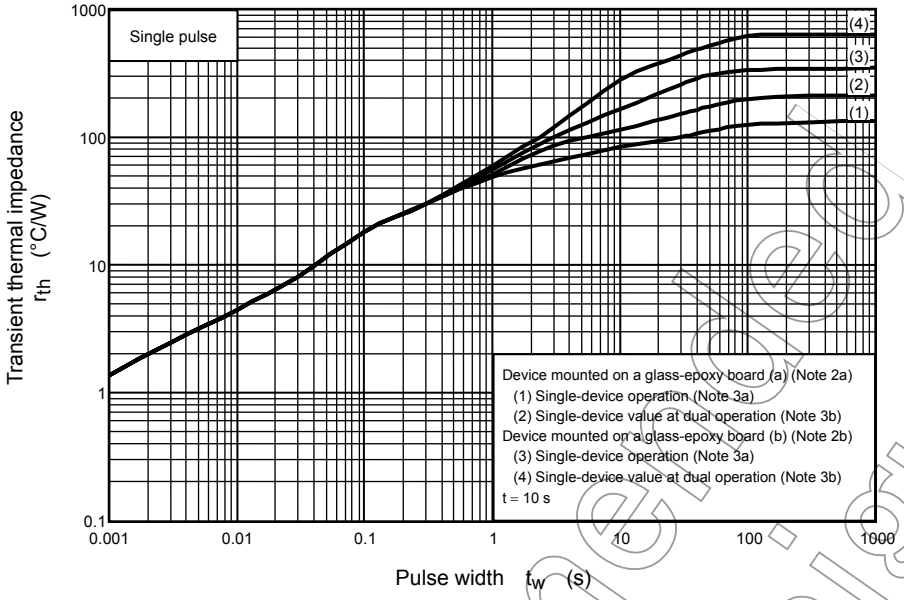


Dynamic input/output characteristics

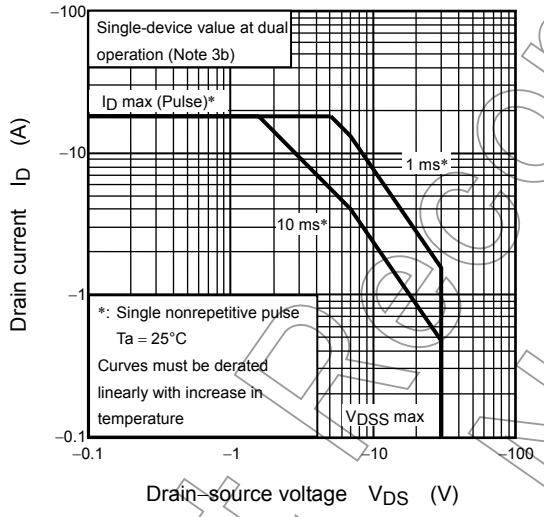


P-ch

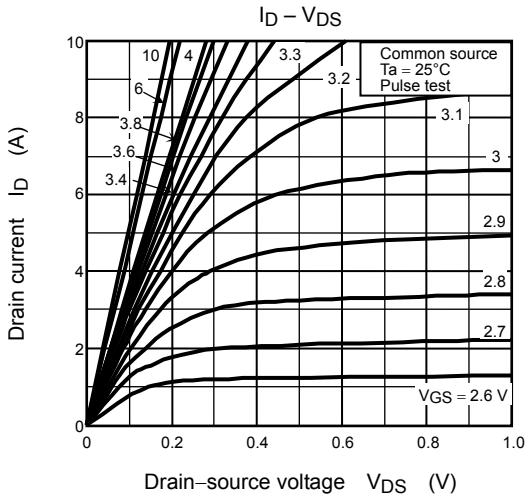
$r_{th} - t_w$

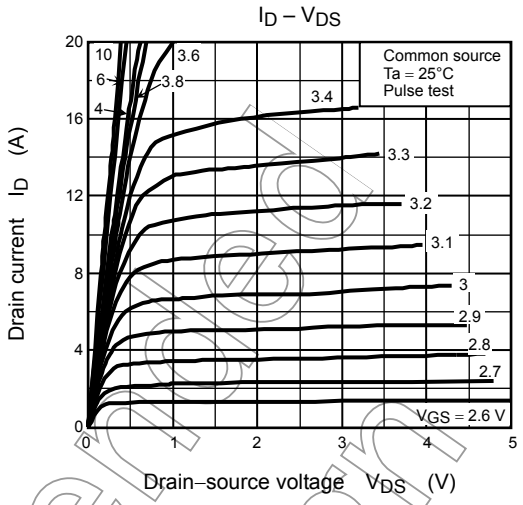


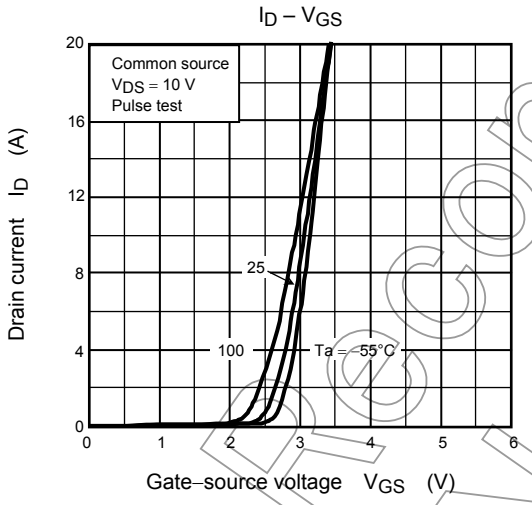
Safe operating area

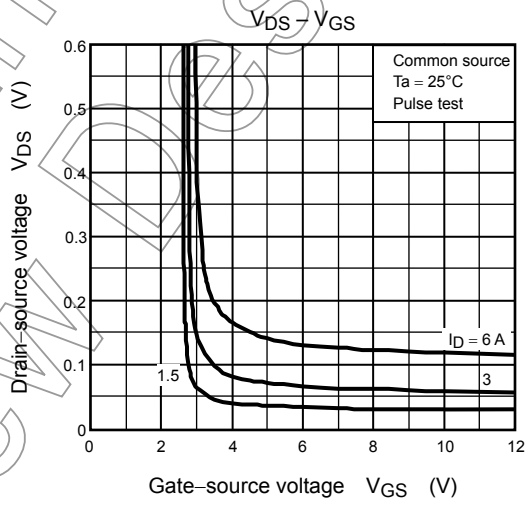


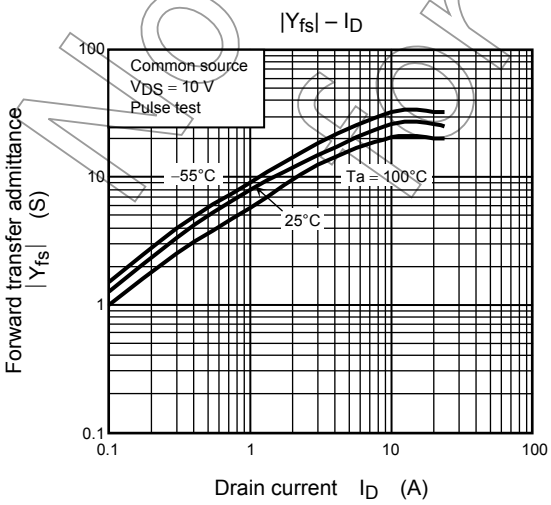
N-ch

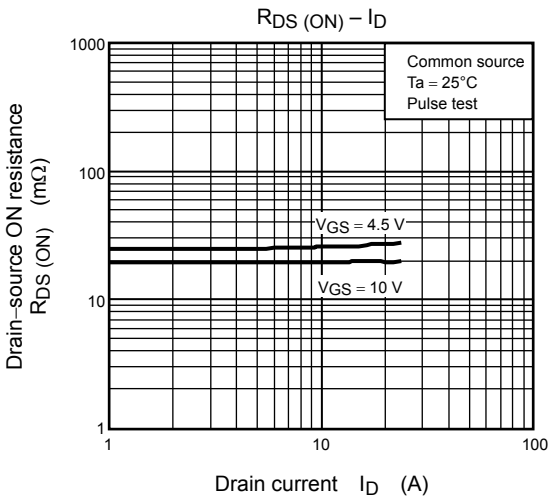






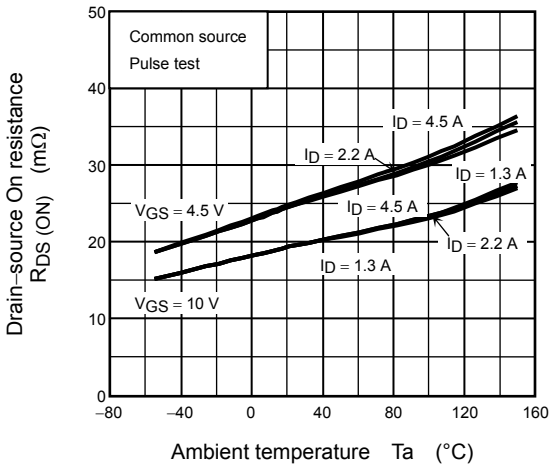




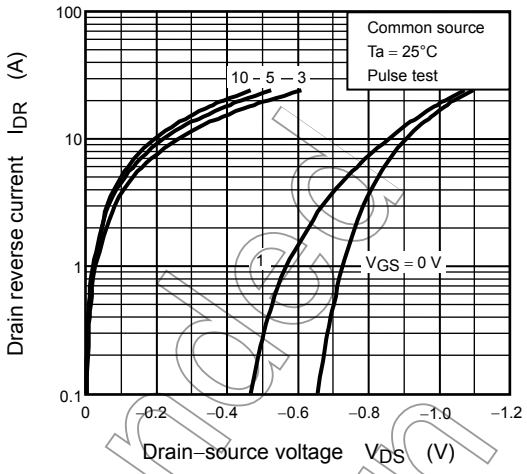


N-ch

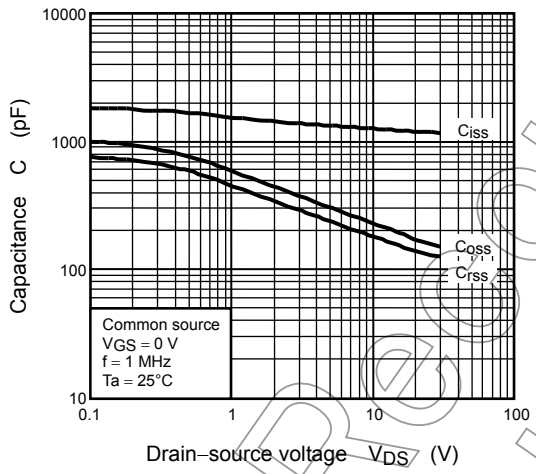
$R_{DS\ (ON)}$ – Ta



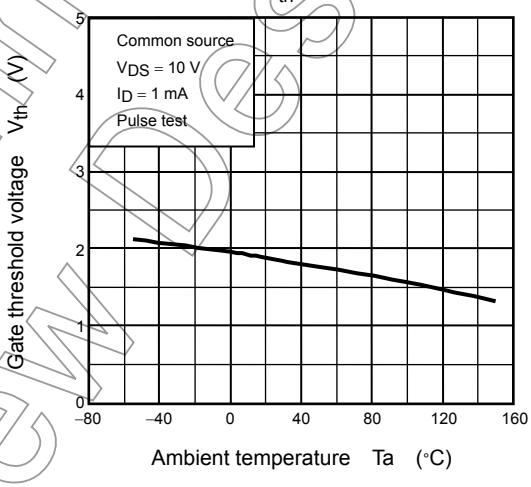
I_{DR} – V_{DS}



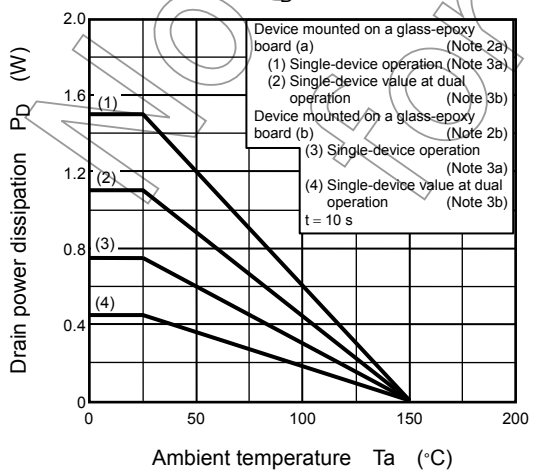
C – V_{DS}



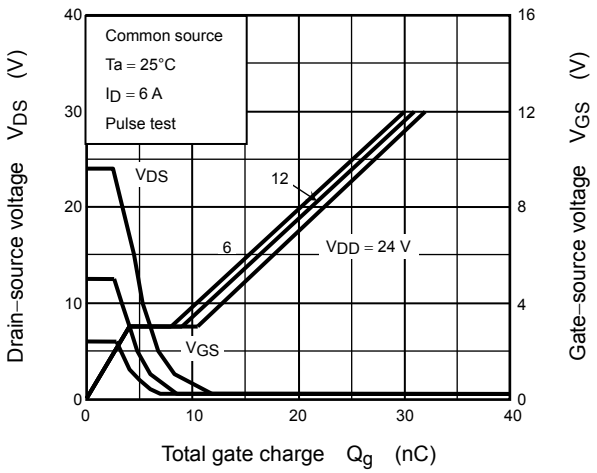
V_{th} – Ta



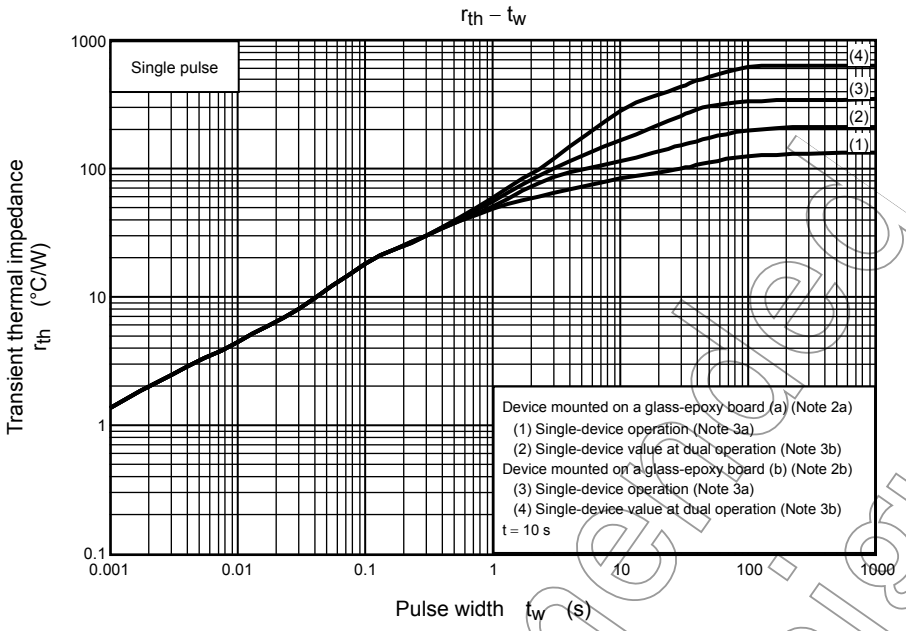
P_D – Ta

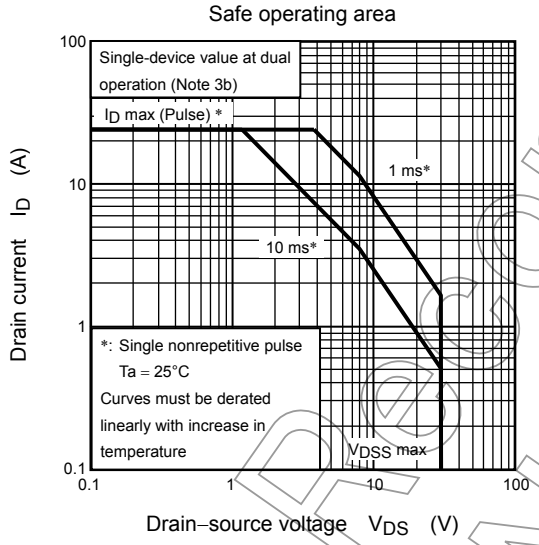


Dynamic input/output characteristics



N-ch





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